

NOT RECOMMENDED FOR NEW DESIGN **USE DMC2053UVT**



DMC2038LVT

COMPLEMENTARY PAIR ENHANCEMENT MODE MOSFET

Product Summary

Device	BV _{DSS}	R _{DS(ON)}	I _D T _A = +25°C
Q1	201/	$35m\Omega$ @ $V_{GS} = 4.5V$	4.5A
Qi	Q1 20V	$56m\Omega$ @ $V_{GS} = 1.8V$	3.5A
Q2 -20V	201/	74 m $Ω$ @ V_{GS} = -4.5 V	-3.1A
Q2	-20V	$168m\Omega$ @ $V_{GS} = -1.8V$	-2.0A

Description

This MOSFET is designed to minimize the on-state resistance (R_{DS(ON)}) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

- Motor Control
- **Power Management Functions**
- DC-DC Converters
- Backlighting

Features

- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Fast Switching Speed
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

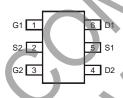
Mechanical Data

- Case: TSOT26
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 @3
- Terminal Connections Indicator: See Diagram
 - Weight: 0.013 grams (Approximate)

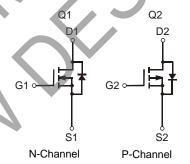


TSOT26

Top View



Top View Pin Configuration



Ordering Information (Note 5)

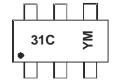
Part Number	Compliance	Case	Packaging
DMC2038LVT-7	Standard	TSOT26	3000/Tape & Reel
DMC2038LVTQ-7	Automotive	TSOT26	3000/Tape & Reel

Notes:

- No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and 1000ppm antimony compounds.
- 4. Automotive products are AEC-Q101 qualified and are PPAP capable. Automotive, AEC-Q101 and standard products are electrically and thermally the same, except where specified. For more information, please refer to https://www.diodes.com/quality/.

 5. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



31C = Product Type Marking Code YM = Date Code Marking Y = Year (ex: F = 2018)M = Month (ex: 9 = September)

Date Code Kev

Year	201	7	2018		2019	20	20	2021		2022	2	2023
Code	E		F		G	ŀ	1	I		J		K
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D

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Maximum Ratings N-CHANNEL – Q1 (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit	
Drain-Source Voltage		V _{DSS}	20	V	
Gate-Source Voltage			V _{GSS}	±12	V
Steady State		$T_A = +25$ °C $T_A = +70$ °C	I _D	3.7 3.0	Α
Continuous Drain Current (Note 6) V _{GS} = 4.5V	t<10s	$T_A = +25$ °C $T_A = +70$ °C	I _D	4.1 3.2	Α
Continuous Drain Current (Note 7) $V_{GS} = 4.5V$ $Steady State T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$ $t<10s T_A = +25^{\circ}C$ $T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$			I _D	4.5 3.6	А
			I _D	5.2 4.2	А
Maximum Continuous Body Diode Forward Current	t (Note 7)	I _S	1.5	Α	
Pulsed Drain Current (10μs Pulse, Duty Cycle = 1%	6)		I _{DM}	25	Α

Maximum Ratings P-CHANNEL – Q2 (@T_A = +25°C, unless otherwise specified.)

Characteristic			. <	Symbol	Value	Unit
Drain-Source Voltage				V _{DSS}	-20	V
Gate-Source Voltage				V _{GSS}	±12	V
Continuous Drain Current (Note 6) V _{GS} = -4.5V		$T_A = +25$ °C $T_A = +70$ °C	7	I _D	-2.6 -2.1	А
		$T_A = +25$ °C $T_A = +70$ °C		I _D	-2.9 -2.4	А
		$T_A = +25$ °C $T_A = +70$ °C	<	I _D	-3.1 -2.5	А
Continuous Drain Current (Note 7) V _{GS} = -4.5V	t<10s	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$		ID	-3.8 -3.0	А
Maximum Continuous Body Diode Forward Current (Note 7)				Is	-1.5	Α
Pulsed Drain Current (10µs Pulse, Duty Cycle	6)			I _{DM}	-17	Α

Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Units
Total Power Dissipation (Note 6)	$T_A = +25$ °C	D-	0.8	W
Total Power Dissipation (Note 6)	T _A = +70°C	P_{D}	0.5	VV
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	0	168	°C/W
Thermal Resistance, suriction to Ambient (Note 0)	t<10s	$R_{\theta JA}$	120	C/VV
Total Power Dissipation (Note 7)	$T_A = +25$ °C	D	1.1	W
Total Fower Dissipation (Note 1)	$T_A = +70$ °C	P_{D}	0.7	VV
Thermal Registance, Junction to Ambient (Note 7)	Steady State	D	114	
Thermal Resistance, Junction to Ambient (Note 7)	t<10s	$R_{\theta JA}$	72	°C/W
Thermal Resistance, Junction to Case (Note 7)		$R_{ heta JC}$	39	
Operating and Storage Temperature Range		$T_{J,}T_{STG}$	-55 to +150	°C

Notes: 6. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.

7. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

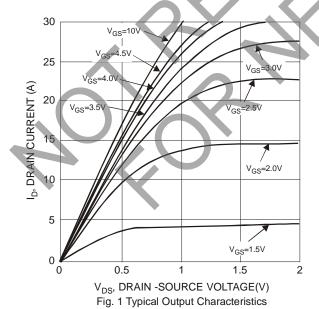


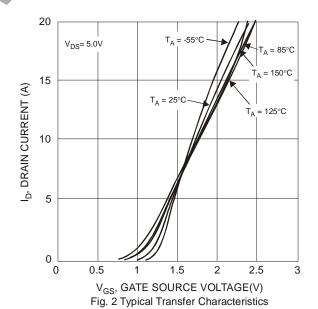
Electrical Characteristics N-CHANNEL – Q1 (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 8)					•	
Drain-Source Breakdown Voltage	BV _{DSS}	20		_	V	$V_{GS} = 0V, I_D = 250\mu A$
Zero Gate Voltage Drain Current @T _C = +25°C	I _{DSS}	_	_	1.0	μA	V _{DS} = 16V, V _{GS} = 0V
Gate-Source Leakage	I _{GSS}	_	_	±100	nA	$V_{GS} = \pm 12V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 8)						
Gate Threshold Voltage	V _{GS(TH)}	0.4	_	1.0	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$
			27	35		$V_{GS} = 4.5V, I_D = 4.0A$
Static Drain-Source On-Resistance	R _{DS(ON)}		33	43	mΩ	$V_{GS} = 2.5V$, $I_D = 2.5A$
		_	43	56		$V_{GS} = 1.8V, I_D = 1.5A$
Forward Transfer Admittance	Y _{fs}	_	9	_	S	$V_{DS} = 5V, I_D = 3.4A$
Diode Forward Voltage	V_{SD}	0.4	_	1.1	V	$V_{GS} = 0V, I_{S} = 1A$
DYNAMIC CHARACTERISTICS (Note 9)						
Input Capacitance	C _{iss}		400	530	pF	
Output Capacitance	Coss		70	90	pF	$V_{DS} = 10V, V_{GS} = 0V,$ f = 1.0MHz
Reverse Transfer Capacitance	Crss	_	65	100	pF	1 = 1.0WHZ
Gate Resistance	R_g	_	1.9	-	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$
Total Gate Charge (V _{GS} = 4.5V)	Q_g	-	5.7	<i></i>	nC	
Total Gate Charge (V _{GS} = 10V)	Qg		12	17	nC	V 45V I 5.00
Gate-Source Charge	Qgs	7	0.7	-(nC	$V_{DS} = 15V, I_D = 5.8A$
Gate-Drain Charge	Q _{gd}		1.4	/_	nC	
Turn-On Delay Time	t _{D(ON)}	1	5	10	ns	
Turn-On Rise Time	t_R	7/-	8	16	ns	$V_{DS} = 10V, V_{GS} = 4.5V,$
Turn-Off Delay Time	t _D (OFF)	_	25	40	ns	$R_G = 6\Omega$, $I_{DS} = 1A$
Turn-Off Fall Time	tF	_	8	16	ns	

Notes: 8. Short duration pulse test used to minimize self-heating effect.

9. Guaranteed by design. Not subject to product testing.

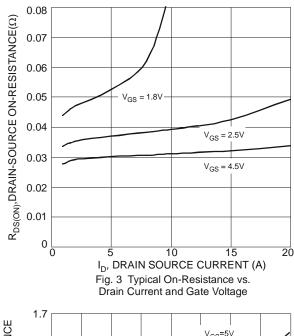


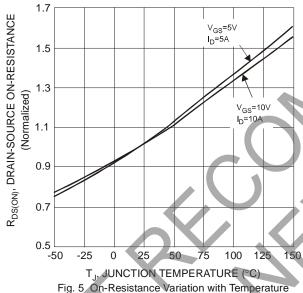




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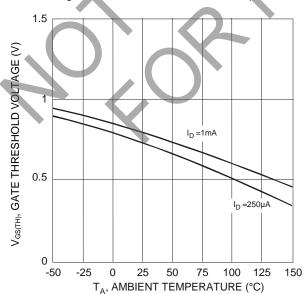
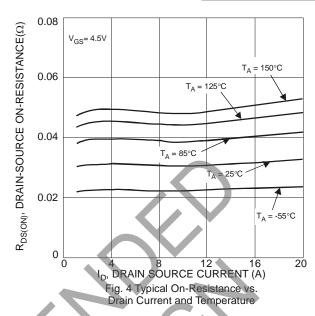


Fig. 7 Gate Threshold Variation vs. Ambient Temperature



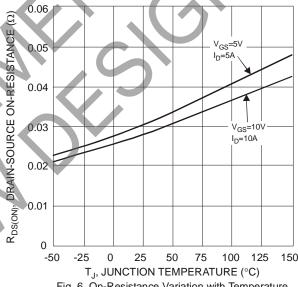
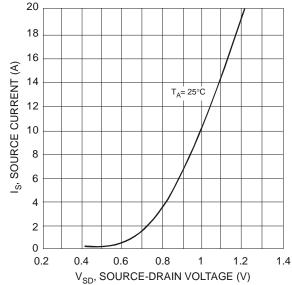
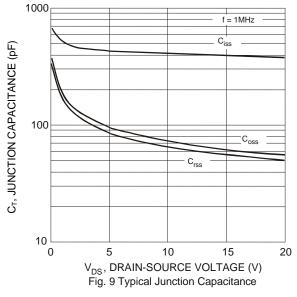
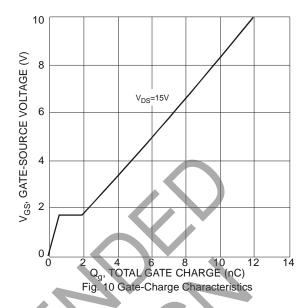


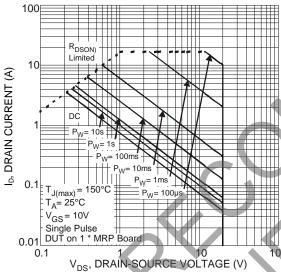
Fig. 6 On-Resistance Variation with Temperature

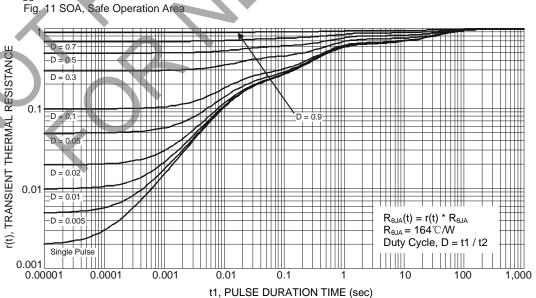












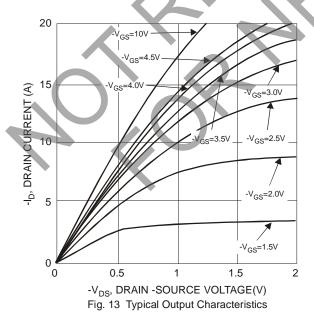


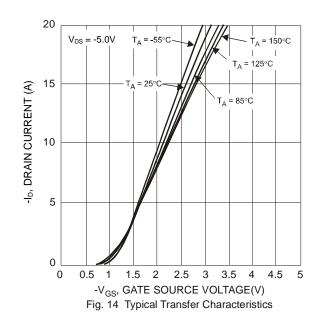
Electrical Characteristics P-CHANNEL - Q2 (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 8)						
Drain-Source Breakdown Voltage	BV _{DSS}	-20	_	1	V	$V_{GS} = 0V, I_D = -250\mu A$
Zero Gate Voltage Drain Current @T _C = +25°C	I _{DSS}	_	_	-1.0	μA	V _{DS} = -16V, V _{GS} = 0V
Gate-Source Leakage	I _{GSS}	_	_	±100	nA	$V_{GS} = \pm 12V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 8)						
Gate Threshold Voltage	V _{GS(TH)}	-0.4	_	-1.0	V	$V_{DS} = V_{GS}$, $I_D = -250\mu A$
		-	57	74		$V_{GS} = -4.5V$, $I_D = -3.0A$
Static Drain-Source On-Resistance	R _{DS(ON)}	_	76	110	mΩ	$V_{GS} = -2.5V$, $I_D = -1.5A$
		_	102	168		V _{GS} = -1.8V, I _D = -1.0A
Forward Transfer Admittance	Y _{fs}	-	10	_	S	$V_{DS} = -5V, I_D = -3.0A$
Diode Forward Voltage	V_{SD}	_	-0.8	-1.0	V	$V_{GS} = 0V, I_{S} = -0.6A$
DYNAMIC CHARACTERISTICS (Note 9)						
Input Capacitance	C _{iss}	_	530	705	pF	V 20V V
Output Capacitance	Coss		70	95	pF	$V_{DS} = -10V, V_{GS} = 0V,$ f = 1.0MHz
Reverse Transfer Capacitance	C _{rss}		60	90	pF	1 - 1.00012
Gate Resistance	R_g	— ·	72		Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$
Total Gate Charge (V _{GS} = -4.5V)	Qg	-	7	10	nC	
Total Gate Charge (V _{GS} = -10V)	Qg	/	14	_	nC	45)/ 1 60
Gate-Source Charge	Qgs	1-	0.95	,-(nC	$V_{DS} = -15V, I_{D} = -6A$
Gate-Drain Charge	Q _{gd}	17	1.2		nC	
Turn-On Delay Time	t _{D(ON)}		11	20	ns	
Turn-On Rise Time	t _R		12	22	ns	$V_{DS} = -10V, V_{GS} = -4.5V,$
Turn-Off Delay Time	t _{D(OFF)}	_	21	34	ns	$R_G = 6\Omega$, $I_S = -1A$
Turn-Off Fall Time	t _F		13	23	ns	

Notes:

- 8. Short duration pulse test used to minimize self-heating effect.
 9. Guaranteed by design. Not subject to product testing.

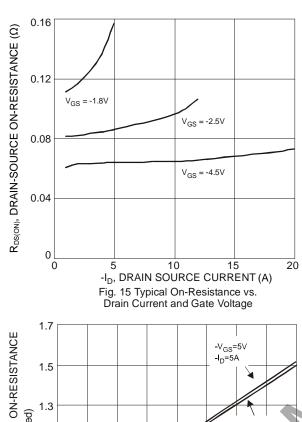


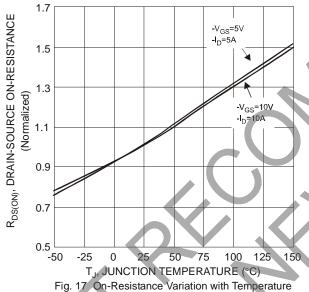




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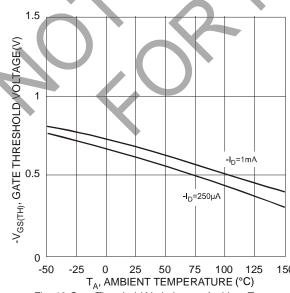
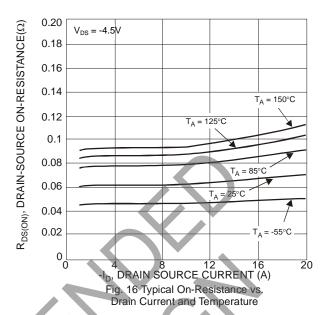
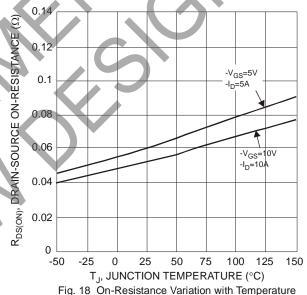


Fig. 19 Gate Threshold Variation vs. Ambient Temperature



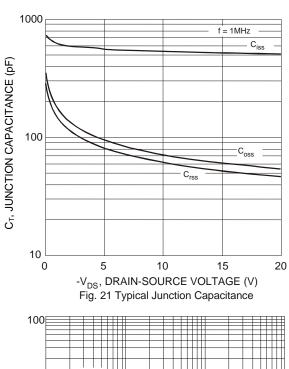


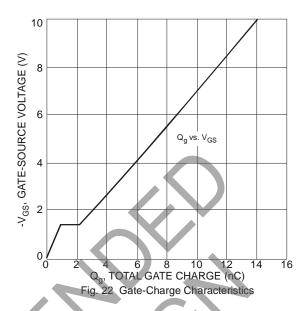
18 16 SOURCE CURRENT (A) T_A= 25°C 14 12 10 8 6 2 0 0.2 0.4 0.6 8.0 1 1.2 1.4 1.6 -V_{SD}, SOURCE-DRAIN VOLTAGE (V)

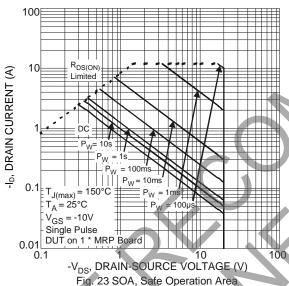
Fig. 20 Diode Forward Voltage vs. Current

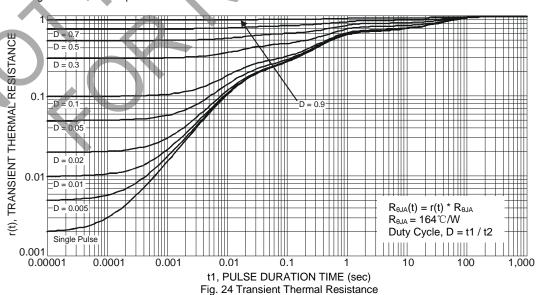
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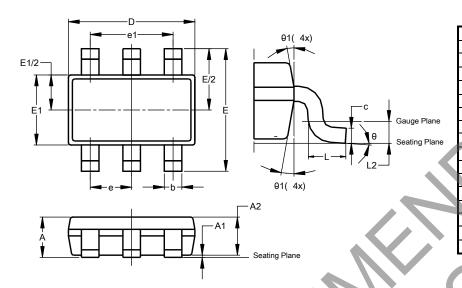


DMC2038LVT

Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

TSOT26

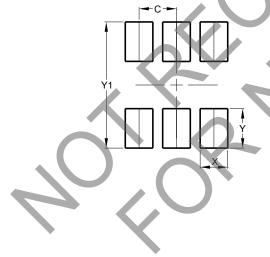


TSOT26								
Dim	Min Max Typ							
Α	-	1.00	-					
A 1	0.010	0.100	-					
A2	0.840	0.900	_					
D	2.800	3.000	2.900					
Е	2	.800 BS	С					
E1	1.500	1.700	1.600					
b	0.300	0.450	-					
n	0.120	0.200	_					
е	0	.950 BS	C					
e1	1	.900 BS	C					
	0.30	0.50	-					
L2		.250 BS	C					
θ	0°	8°	4°					
θ1	4°	12°	_					
A	All Dimensions in mm							

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

TSOT26



Dimensions	Value (in mm)
С	0.950
Х	0.700
Y	1.000
Y1	3 199



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 - 2. support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in significant injury to the user.
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